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|-----------------------------------|---------------------------------------|--|-------------|
| <b>Notice of References Cited</b> | Application/Control No.<br>09/672,287 | Applicant(s)/Patent Under<br>Reexamination<br>MATSUBARA ET AL. |             |
|                                   | Examiner<br>Dah-Wei D. Yuan           | Art Unit<br>1745   | Page 1 of 1 |

**U.S. PATENT DOCUMENTS**

| * |   | Document Number<br>Country Code-Number-Kind Code | Date<br>MM-YYYY | Name | Classification |
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**FOREIGN PATENT DOCUMENTS**

| * |   | Document Number<br>Country Code-Number-Kind Code | Date<br>MM-YYYY | Country | Name         | Classification |
|---|---|--|-----------------|---------|--------------|----------------|
|   | N | JP 10-21913                                      | 01-1998         | Japan   | Igawa et al. | H01M 4/58      |
|   | O |  |                 |         |              |                |
|   | P |  |                 |         |              |                |
|   | Q |  |                 |         |              |                |
|   | R |  |                 |         |              |                |
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|   | T |  |                 |         |              |                |

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|---|---|---|
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